35V N-CHANNEL ENHANCEMENT MODE MOSFET

SUMMARY

 $V(BR)DSS = 35V: RDS(on) = 0.050\Omega: ID = 6.7A$

DESCRIPTION

This new generation of high cell density planar MOSFETs from Zetex utilises a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.

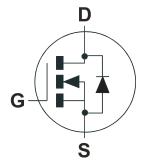


FEATURES

- Low on-resistance
- · Fast switching speed
- · Low threshold
- · Low gate drive
- SOT223 package

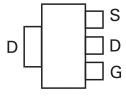
APPLICATIONS

- 50W Class D Audio Output Stage
- Motor Control



ORDERING INFORMATION

DEVICE	REEL SIZE	TAPE WIDTH	QUANTITY PER REEL
ZXM64N035GTA	7"	12mm	1000 units
ZXM64N035GTC	13"	12mm	4000 units



Top View

DEVICE MARKING

ZXM6 4N035



ABSOLUTE MAXIMUM RATING

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	VDSS	35	V
Gate-Source Voltage	VGS	±20	V
Continuous Drain Current (VGS=10V; TA=25°C)(b) (VGS=10V; TA=70°C)(b) (VGS=10V; TA=25°C)(a)	ID	6.7 5.4 4.8	А
Pulsed Drain Current (c)	IDM	30	А
Continuous Source Current (Body Diode) (b)	IS	2.4	А
Pulsed Source Current (Body Diode)(c)	ISM	30	A
Power Dissipation at TA=25°C (a) Linear Derating Factor	PD	2.0 16	W mW/°C
Power Dissipation at TA=25°C (b) Linear Derating Factor	PD	3.9 31	W mW/°C
Operating and Storage Temperature Range	Tj:Tstg	-55 to +150	°C

THERMAL RESISTANCE

PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient (a)	$R_{\theta JA}$	62.5	°C/W
Junction to Ambient (b)	R_{θ} JA	32	°C/W

NOTES

- (a) For a device surface mounted on 25mm \times 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions
- (b) For a device surface mounted on FR4 PCB measured at t≤10 secs.
- (c) Repetitive rating 25mm x 25mm FR4 PCB, D=0.05 pulse width limited by maximum junction temperature.



ELECTRICAL CHARACTERISTICS (at $T_A = 25$ °C unless otherwise stated).

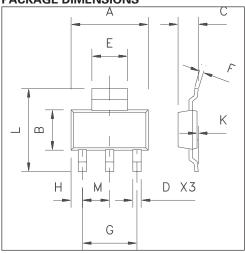
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.	
STATIC		•		•	•		
Drain-Source Breakdown Voltage	V(BR)DSS	35			V	I _D =250μA, V _G S=0V	
Zero Gate Voltage Drain Current	IDSS			1	μА	V _{DS} =35V, V _{GS} =0V	
Gate-Body Leakage	IGSS			100	nA	V _{GS} =±20V, V _{DS} =0V	
Gate-Source Threshold Voltage	VGS(th)	1.0			V	I _D =250μA, V _{DS} = V _{GS}	
Static Drain-Source On-State Resistance (1)	R _{DS(on)}			0.050 0.062	Ω	V _{GS} =10V, I _D =3.7A V _{GS} =4.5V, I _D =1.9A	
Forward Transconductance (1)(3)	9fs	4.3			S	V _{DS} =10V,I _D =1.9A	
DYNAMIC (3)		•	•	•	•		
Input Capacitance	C _{iss}		950		pF		
Output Capacitance	Coss		200		pF	V _{DS} =25V, V _{GS} =0V, f=1MHz	
Reverse Transfer Capacitance	C _{rss}		50		pF	1	
SWITCHING(2) (3)		•		•	•		
Turn-On Delay Time	td(on)		4.2		ns		
Rise Time	t _r		4.6		ns	V _{DD} =15V, I _D =3.7A	
Turn-Off Delay Time	td(off)		20.5		ns	R _G =6.0Ω, V _G S=10V	
Fall Time	tf		8		ns	1	
Total Gate Charge	Q_g			27	nC		
Gate-Source Charge	Qgs			5	nC	V _{DS} =24V,V _{GS} =10V, I _D =3.7A	
Gate-Drain Charge	Q _{gd}			4.5	nC		
SOURCE-DRAIN DIODE	•						
Diode Forward Voltage (1)	V _{SD}			0.95	V	T _J =25°C, I _S =3.7A, V _{GS} =0V	
Reverse Recovery Time (3)	t _{rr}		24.5		ns	TJ=25°C, IF=3.7A, di/dt= 100A/μs	
Reverse Recovery Charge (3)	Orr		19.1		nC		

NOTES

- (1) Measured under pulsed conditions. Width=300 $\mu s.$ Duty cycle $\leq 2\%$.
- $\begin{tabular}{ll} \end{tabular} \begin{tabular}{ll} \textbf{(2) Switching characteristics are independent of operating junction temperature.} \end{tabular}$
- (3) For design aid only, not subject to production testing.

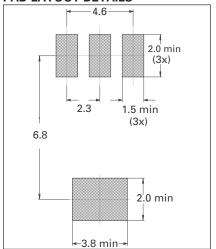
ZETEX

PACKAGE DIMENSIONS



DIM	Millimetres		Inc	hes	
	Min	Max	Min	Max	
А	6.3	6.7	0.248	0.264	
В	3.3	3.7	0.130	0.146	
С	-	1.7	-	0.067	
D	0.6	0.8	0.024	0.031	
E	2.9	3.1	0.114	0.122	
F	0.24	0.32	0.009	0.13	
G	NOM 4.6		NOM 0.181		
Н	0.85	1.05	0.033	0.041	
К	0.02	0.10	0.0008	0.004	
L	6.7	7.3	0.264	0.287	
М	NOM 2.3		NOM 0.0905		

PAD LAYOUT DETAILS



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